TMCM-1690-TMCL Hardware Manual

HW Version V1.0 | 19-101827B, Rev 1: 04/24

The TMCM-1690-TMCL is a single axis FOC servo controller gate driver module for 3-phase brushless direct current (BLDC) and DC motors with up to 1.5A gate drive current and +60V (+48 V nominal) supply. It offers universal asynchronous receiver-transmitter (UART) (RS232-/RS485-ready) and universal asynchronous receiver-transmitter (UART) interfaces with TMCL protocol support for communication. TMCM-1690-TMCL supports incremental encoders, digital hall sensors, and absolute encoder as position feedback.



Applications

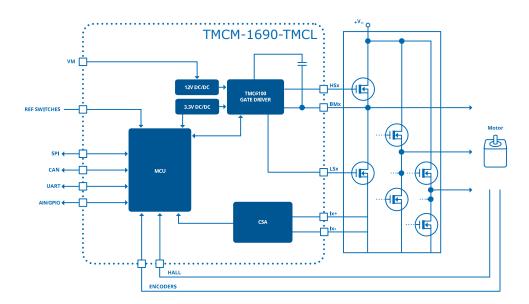
- Robotics
- Laboratory Automation
- Manufacturing

- Factory Automation
- Servo Drives
- Motorized Tables and Chairs

Features

- Supply Voltage +10 to +60V DC
- FOC Servo Controller and Gate Driver Module for BLDC and DC Motors
- 0.5A/1.0A/1.5A Gate Drive current
- Up to 120kHz PWM Frequency
- · Onboard Current-sense Amplifiers
- Supports UART (RS232/RS485-ready) and CAN Interface
- Supports Incremental Encoders (ABN), Digital HALL Sensors, Absolute SPI Encoders
- Reference Switch Inputs
- Compact Size (27mm x 22.5mm)
 - Industrial BLDC and DC Motor Drives

Simplified Block Diagram



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1 Features

The TMCM-1690-TMCL is a single axis field-oriented control (FOC) servo controller gate driver module for 3-phase BLDC and DC motors with up to 1.5A gate drive current and +60V supply. It offers UART (RS232-/RS485-ready) and CAN interfaces with TMCL protocol for communication. TMCM-1690-TMCL supports incremental encoders, digital hall sensors, and absolute SPI encoder as position feedback.

Controller and Driver

- Gate drive current: 1.5A
- Supply voltage +10V to +60V DC (+48V nominal)
- Field-oriented control with up to 100kHz PWM and current control loop
- Temperature rating: -30°C...+60°C

Position Feedback

- Incremental encoders (ABN)
- · Digital hall sensors
- Absolute SPI encoder support for Analog Devices ADA4573 and RLS AM4096

Interfaces

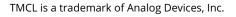
- Digital UART interface (RS232 with external transceiver on base board)
- Digital RS485 interface with up-to 1Mb/s (external transceiver needed on base board)
- Digital CAN interface with up-to 1Mb/s (external transceiver needed on base board)
- 2x general purpose digital inputs/outputs (0V...+3.3V input range)
- 1x analog input (0V...+3.3V input range)

Mechanical data

- Board size: 27.0mm x 22.5mm
- Edge castellation with 54 half-cut plated through-hole pins at 1.5mm pin pitch

Software

• TMCL™ remote (direct mode) and standalone operation (memory for up to 1024 TMCL commands), fully supported by TMCL-IDE (PC based integrated development environment). Further information is given in the TMCM-1690-TMCL TMCL firmware manual.





2 Order Codes

The TMCM-1690-TMCL comes preprogrammed with ADI Trinamic TMCL protocol firmware. Specific information on the TMCL protocol is provided in the separate firmware manual.

Order Code	Description	Size (LxWxH)
TMCM-1690-TMCL	60V/10A _{RMS} FOC servo controller and gate driver module for BLDC and DC motors with TMCL software stack	27.0mm x 22.5mm x 3mm
TMCM-1690-TMCL-T	60V/10A _{RMS} FOC servo controller and gate driver module for BLDC and DC motors with TMCL software stack	27.0mm x 22.5mm x 3mm

Table 1: TMCM-1690-TMCL Order Codes

(-T = tape and reel version)



3 Mechanical and Electrical Interfacing

3.1 Size of the board

The board with the controller/driver electronics has an overall size of 27.0mm x 22.5mm x 3mm.

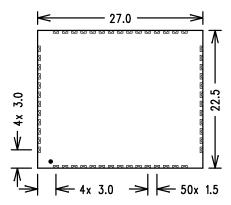


Figure 1: Board Dimensions and Pin Positions (All Values in mm)

3.2 Board mounting considerations

The pins of the board have the dimensions of $1.0 \text{mm} \times 0.65 \text{mm}$. The recommended pad size is $1.0 \text{mm} \times 1.3 \text{mm}$ with the center positioned on the board outline such that the part extending under the board is 1:1 with the pin.

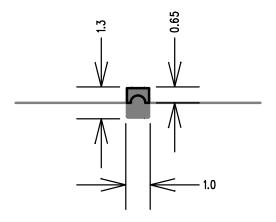


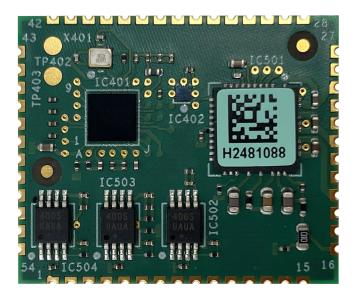
Figure 2: Pin Dimensions and Recommended Pad Size (All Values in mm)



4 Pinout and Pin Descriptions

4.1 Package Pinout

Pin numbers are also printed in the top silkscreen of TMCM-1690-TMCL.



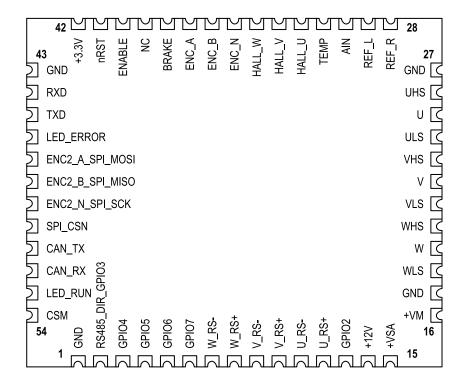


Figure 3: TMCM-1690-TMCL Pinout (Top View)



4.2 Pin Table

			Pin Assignn	nents
Pin	Name	Direction	Ref Supply	Description
1, 17, 27, 43	GND	_	_	System ground
2	RS485_DIR_GPIO3	in/out	+3.3V	RS485 transceiver direction control output or software configurable general purpose IO. Output mode = push-pull. Input mode with configurable built-in pull-up resistor.
3	GPIO4	in/out	+3.3V	Software configurable general purpose IO. Output mode = push-pull. Input mode with configurable built-in pull-up resistor.
4	GPIO5	in/out	+3.3V	Software configurable general purpose IO. Output mode = push-pull. Input mode with configurable built-in pull-up resistor.
5	GPIO6	in/out	+3.3V	Software configurable general purpose IO. Output mode = push-pull. Input mode with configurable built-in pull-up resistor.
6	GPIO7	in/out	+3.3V	Software configurable general purpose IO. Output mode = push-pull. Input mode with configurable built-in pull-up resistor.
7	W_RS-	input	+3.3V	Motor phase W load-side current-sense resistor connection
8	W_RS+	input	+3.3V	Motor phase W power-side current-sense resistor connection
9	V_RS-	input	+3.3V	Motor phase V load-side current-sense resistor connection
10	V_RS+	input	+3.3V	Motor phase V power-side current-sense resistor connection
11	U_RS-	input	+3.3V	Motor phase U load-side current-sense resistor connection
12	U_RS+	input	+3.3V	Motor phase U power-side current-sense resistor connection
13	GPIO2	output	+3.3V	Software configurable general purpose IO. Output mode = push-pull. Input mode with configurable built-in pull-up resistor.



Pin	Name	Direction	Ref Supply	Description
14	+12V	in/out	_	Output of internal gate voltage regulator and supply pin of low side gate drivers. Attach $2.2\mu\mathrm{F}$ to $22\mu\mathrm{F}$ ceramic capacitor to GND plane near to pin for best performance. Use at least 5 to 10 times more capacity than for bootstrap capacitors. In case an external gate voltage supply is available, tie VSA and +12V to the external supply. See section on power supply requirements.
15	+VSA	input	_	Analog gate driver supply for internal regulators. Provide a 100nF filtering capacitor to GND. See section on power supply requirements.
16	+VM	input	_	Motor supply voltage. Provide filtering capacity near pin with short loop to GND plane. Must be tied to the positive bridge supply voltage. Severe ringing must be avoided. See section on power supply requirements.
18	LSW	output	+VM	Low-side Gate Drive Output. Connect to the gate of the W phase low-side n-channel MOS-FET.
19	W	input	+VM	Bridge center and bootstrap capacitor negative connection. Connect to source pin of the high side W phase MOSFET.
20	HSW	output	+VM	High-side Gate Drive Output. Connect to the gate of the W phase high-side n-channel MOSFET.
21	LSV	output	+VM	Low-side Gate Drive Output. Connect to the gate of the V phase low-side n-channel MOS-FET.
22	V	input	+VM	Bridge center and bootstrap capacitor negative connection. Connect to source pin of the high side V phase MOSFET.
23	HSV	output	+VM	High-side Gate Drive Output. Connect to the gate of the V phase high-side n-channel MOS-FET.
24	LSU	output	+VM	Low-side Gate Drive Output. Connect to the gate of the U phase low-side n-channel MOS-FET.
25	U	input	+VM	Bridge center and bootstrap capacitor negative connection. Connect to source pin of the high side U phase MOSFET.
26	HSU	output	+VM	High-side Gate Drive Output. Connect to the gate of the U phase high-side n-channel MOS-FET.



Pin	Name	Direction	Ref Supply	Description
28	REF_R	input	+3.3V	Right reference switch input. When enabled in software, the REF_R switch input stops motor movement in positive direction (position counter increasing) while activated.
29	REF_L	input	+3.3V	Left reference switch input. When enabled in software, the REF_L input stops motor movement in negative direction (position counter decreasing) while activated.
30	AIN	input	+3.3V	General purpose analog input using the integrated ADC of the on-board microcontroller. The resolution of this converter is 12 bit. The analog input can also be used as a digital input. The analog input voltage range is 0V to +3.3V.
31	TEMP	input	+3.3V	Analog input for temperature measurement. Connect a $10k\Omega$ thermal resistor (NTC) to $+3.3V$ and a $2.2k\Omega$ resistor to ground from this pin.
32	HALL_U	input	+3.3V	Digital Hall sensor input, channel U
33	HALL_V	input	+3.3V	Digital Hall sensor input, channel V
34	HALL_W	input	+3.3V	Digital Hall sensor input, channel W
35	ENC_N	input	+3.3V	Incremental encoder input index channel
36	ENC_B	input	+3.3V	Incremental encoder input channel B
37	ENC_A	input	+3.3V	Incremental encoder input channel A
38	BRAKE	output	+3.3V	PWM output for brake chopper circuit. The BRAKE output can be used to limit the supply voltage. Connect it to an external MOSFET with load resistor to dump energy into the resistor.
39	NC	_	_	Not connected.
40	ENABLE	input	+3.3V	Enable pin. Drive low to put TMCM-1690-TMCL in low power mode. Drive high to +3.3V rail for operation. Pulled low by a built-in pull-up resistor when left open.
41	nRST	input	+3.3V	Resets the entire module when pulled low. As the module is reset automatically on power up, the nRST pin can normally be left open: it is pulled high by a built-in pull-up resistor.
42	+3.3V	input	_	+3.3V logic and interface supply voltage. See section on power supply requirements.
44	RXD	input	+3.3V	UART interface receive line
45	TXD	output	+3.3V	UART interface transmit line
46	LED_ERROR	output	+3.3V	LED output, ERROR status signal



Pin	Name	Direction	Ref Supply	Description
47	ENC2_A_SPI_MOSI	in/out	+3.3V	SPI serial data output (primarily for external absolute encoder) or incremental encoder 2 A input.
48	ENC2_B_SPI_MISO	input	+3.3V	SPI serial data input (primarily for external absolute encoder) or incremental encoder 2 B input.
49	ENC2_N_SPI_SCK	in/out	+3.3V	SPI serial clock (primarily for external absolute encoder) or incremental encoder 2 N input.
50	SPI_CSN	output	+3.3V	SPI chip select output
51	CAN_TX	in/out	+3.3V	CAN interface transmit line
52	CAN_RX	in/out	+3.3V	CAN interface receive line
53	LED_RUN	in/out	+3.3V	LED output, RUN status signal
54	CSM	input	+3.3V	Tie to ground. For future use.

Table 2: Pin Assignments TMCM-1690-TMCL



5 System Architecture

TMCM-1690-TMCL comes with an MCU containing motion control algorithms, a MOSFET gate driver, and three current-sense amplifiers (CSAs). It is designed to be easily mounted either by hand soldering or reflow to a carrier board containing the power stage, user-defined connectors, and minimal support components. The TMCM-1690-TMCL features state of the art field-oriented control (FOC) algorithm using hall or incremental encoder signals for permanent magnet synchronous motors (PMSM) as well as block hall commutation (six step mode) for BLDC motors. Current-, velocity- and position controller are implemented for all commutation modes and can be parameterized using the various supported protocols and interfaces. Absolute encoders can be connected through one of the available serial peripheral/port interfaces if required by the application. The high-level system architecture is shown in Figure 4.

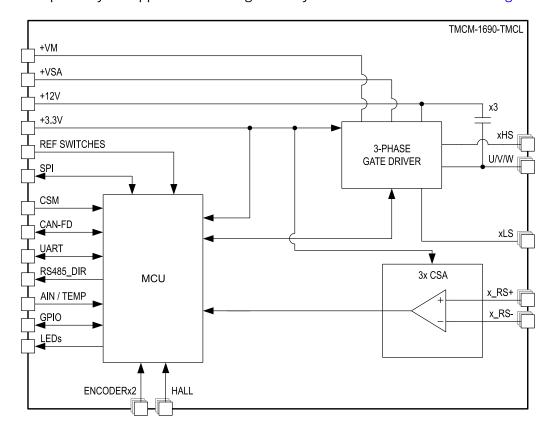


Figure 4: TMCM-1690-TMCL System Architecture



6 External Components

Very few external components are required to get started with the TMCM-1690-TMCL. The following sections highlight the requirements.

6.1 Analog Input

The analog input signal of TMCM-1690-TMCL can be used as a target value to control, for example, torque, velocity, or other parameters. The analog input voltage is routed directly to the TMCM-1690-TMCL microcontroller and is converted with a resolution of 12 bit. AIN is designed for a voltage range between 0V and 3.3V. For higher voltages, use a voltage divider plus optional protection diode, as shown in Figure 5.

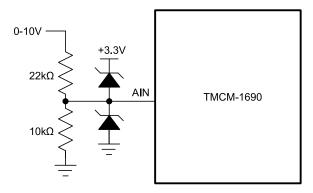


Figure 5: Protection of AIN for Higher Voltage Control

6.2 Power Supply Requirements

Two power supplies are required for the operation of TMCM-1690-TMCL in addition to the motor supply. A 12V VSA supply powers the gate driver, which is used to drive the power stage. A 3.3V I/O power supply is required to operate the motion controller and current-sense amplifiers. The MAXM15068 is a great low-touch candidate for use for the 12V supply and the MAXM17502 is an excellent choice for the 3.3V I/O supply.

In cases where the motor is run at or below 24V, it is possible to eliminate the need for the external 12V power supply by instead relying on the internal 12V LDO on the gate driver. When this configuration is desired, simply separate the +12V and VSA rails, powering VSA from the VM supply and leaving +12V floating. When the motor is run with a supply greater than 24V nominal, the power dissipation in the LDO is too high and VSA should be connected externally to +12V and both should be supplied by a 12V power supply (see Figure 6).



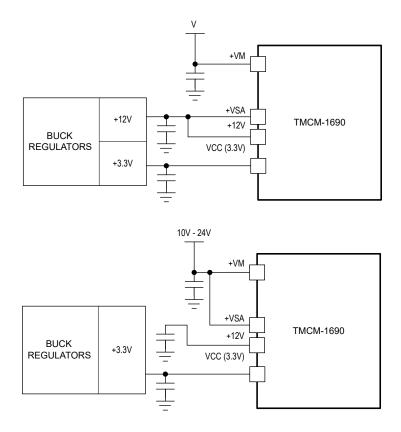


Figure 6: Power Supply Configurations

The TMCM-1690-TMCL includes small bypass capacitances, which filter power supply ripple arising from small local inductances. External bulk capacitances must be placed to handle the much larger board level parasitics and to provide a stable power supply for the TMCM-1690-TMCL. It is recommended that the 3.3V rail be bypassed by minimum $10\mu\text{F}$ of capacitance. The VM and VSA (12V) supplies should be bypassed externally by roughly $9\mu\text{F}$ to $10\mu\text{F}$ minimum as well. To minimize ESR, place two $4.7\mu\text{F}$ capacitors in parallel. All bypass capacitors should be placed as close to the pin as possible.

6.3 Power Stage - MOSFET Bridge

The TMCM-1690-TMCL uses the TMC6100 high-power gate-driver for PMSM servo or BLDC motors. Using six external MOSFETs, the TMCM-1690-TMCL controls motors in power ranges from watts to kilowatts. Software-controlled drive strength allows in-system EME optimization. Programmable safety features like short detection and overtemperature thresholds together with an SPI for diagnostics allow robust and reliable designs. With the TMCM-1690-TMCL, minimal external components are required to build a rugged drive with full protection and diagnostics. The driver is capable of driving the MOSFETS' gates with controlled gate charge current options of 0.5A, 1A, or 1.5A. This allows the user to reduce dynamic losses and improve system efficiency over a broad power range. External series resistors can also be used to further shape the slope of the curve, if necessary.

The selection of power MOSFETs depends on a number of factors, like package size, on-resistance, gate charge, voltage rating, and supplier availability. It is not true that larger, lower RDS-ON MOSFETs are always better since a larger device also has higher capacitances. Larger capacitances may add more ringing in trace inductance and may also lead to increased power dissipation in the gate drive circuitry. MOSFETs should be selected first based on the required motor voltage (adding 5V to 10V of reserve to the peak supply voltage for margin) and the desired maximum current. Current requirements must be met both in terms of the rated current of the device as well as in terms of resistive power losses, which result in



power losses that can be dissipated by the chosen MOSFET package. TMCM-1690-TMCL drives the MOSFET gates with roughly 10V. Therefore, normal 10V specified gate voltage MOSFETs are sufficient. Logic level FETs (4.5V specified RDS-ON) do also work but may be more susceptible to bridge cross-conduction due to lower $V_{GS(th)}$.

The gate-drive current and MOSFET gate resistors R_G (optional) should be chosen based on the MOSFET gate-drain charge (Miller charge) to yield reasonable slope times. Figure 7 shows how the Miller charge influences the switching event.

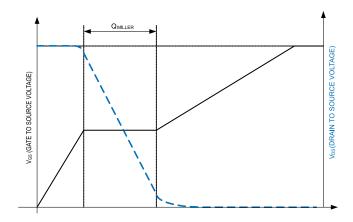


Figure 7: Miller Charge Determines Switching Slope

Figure 8 additionally shows the switching events in different load situations (load pulling the output up or down), and the required bridge brake-before-make time. Note that modern MOSFETs with fast and soft recovery bulk diodes and low reverse recovery charge should be chosen. A small, SMD MOSFET package allows for more compact routing, which reduces the effects of parasitic inductances.

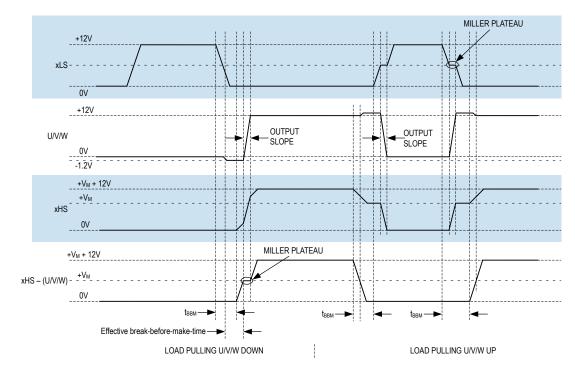


Figure 8: Slopes, Miller Plateau, and Blanking Time



Table 3 offers a rule of thumb for the MOSFET driver current (DRVSTRENGTH setting) and the selection of gate resistors (R_G):

Miller Charge [nC] (typ)	DRVSTRENGTH setting	Gate Resistor R_G [Ω]
<10	0 or 1	≤ 10 (recommended)
10 to 20	0 to 2	≤ 5 (optional)
20 to 80	1 to 3	\leq 2.5 (optional)
>80	3	≤ 1 (optional)

Table 3: MOSFET Miller Charge vs. DRVSTRENGTH Setting and Gate Resistor R_G

Use the lowest gate driver strength setting DRVSTRENGTH giving favorable switching slopes, before increasing the value of the gate series resistors. A slope time of 40ns to 80ns is sufficient and is normally covered by a break-before-make (BBM) time setting of 1 to 4 (4 is default). In case slower slopes have to be used, for example with large MOSFETs, ensure that the break-before-make time sufficiently covers the switching event to avoid bridge cross conduction. The shortest break-before-make time, safely covering the switching event, gives best results. Add roughly 30% of margin to cover manufacturing variations in the MOSFETs and driver.

The TMCM-1690-TMCL provides an increased hold OFF gate current to avoid cross-conduction in the bridge, which can be induced by high dV/dt on the U/V/W node. This protection is less effective when using gate resistors (R_G). Therefore, a diode in parallel with R_G may be required to ensure that the high-side (low-side) MOSFETs are held safely OFF during switching events on the low-side (high-side) MOSFET. Break-before-make timing on the gate driver can be configured per the appropriate firmware user guide based on the version in use.



6.3.1 Tuning of the MOSFET Bridge

To ensure low power dissipation and good EMC behavior a clean switching event with limited ringing is essential. Poor layout and/or improperly selected components can endanger stable operation of the circuit. Therefore, it is important to understand the effect of parasitic trace inductivity and MOSFET reverse recovery.

Stray inductances in power routing cause ringing whenever the opposite MOSFET is in diode conduction prior to switching on a low-side or high-side MOSFET. Diode conduction occurs during break-before-make time whenever the load current is inverse to the following bridge polarity. The MOSFET bulk diode has a certain, type-specific reverse recovery time and charge. This time typically is in the range of a few 10ns. During reverse recovery time, the bulk diode causes high current flow across the bridge. This current is taken from the power supply filter capacitors (see the thick lines in Figure 9). Once the diode opens, parasitic inductances try to keep the current flowing.

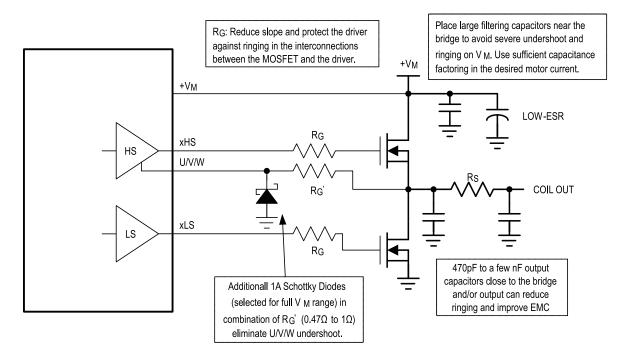


Figure 9: Bridge Protection Options and Power Routing Ringing Mitigation

A high, fast slope results and leads to ringing in all parasitic inductances (see Figure 10, Figure 11, and Figure 12). This ringing may lead to bridge voltage undershooting the GND level as well as fast pulses on the gate driver source and all MOSFET connections. The driver IC must not see spikes on its U/V/W pins to GND going below -5V. Additionally, severe gate driver source ripple can potentially overload the charge-pump circuitry. Measure the voltage directly at the driver pins to driver GND to see the effects of the parasitics with a given layout. The amount of undershoot depends on energy stored in parasitic inductances from low side drain to low side source and to GND (including any sense resistances). When using relatively small MOSFETs, a soft slope control requires a high gate series resistance. This endangers safe MOSFET switch off. Add additional diodes to ensure safe MOSFET off conditions with slow switch-on slopes (Figure 13).



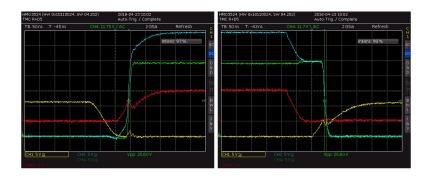


Figure 10: Ringing of Output (Green) and Gate Voltages (Yellow, Blue) with DRVSTRENGTH = 0

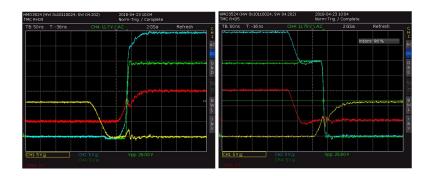


Figure 11: Ringing of Output (Green) and Gate Voltages (Yellow, blue) with DRVSTRENGTH = 2

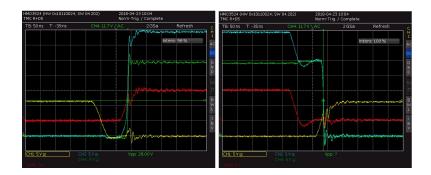


Figure 12: Ringing of Output (Green) and Gate Voltages (Yellow, Blue) with DRVSTRENGTH = 3

Tips for success:

- 1. Use SMD MOSFETs and short interconnections.
- 2. Provide sufficient power filtering capacity close to the bridge and close to VM pin.
- 3. Tune MOSFET switching slopes (measure switch-on event at MOSFET gate) to be slower than the MOSFET bulk diode reverse recovery time. This reduces cross conduction.
- 4. Add optional gate resistors close to MOSFET gate and output capacitors to ensure clean switching and reliable operation by minimizing ringing.
- 5. Some MOSFETs eliminate reverse recovery charge by integrating a fast diode from source to drain.



6.3.2 Bridge Optimization Example

Figure 13 shows a driver for a 15A/60V application using the MOSFET BSC037N08NS (3.7m Ω , 80V, QG = 56nC, t_{RR} = 41ns). The MOSFETs offer roughly 20ns slope time at the lowest driver strength setting. Switching quality is good and signals are clean (see Figure 8). At double drive strength, the slope time halves, and switching events still are clean. When increasing to full gate drive strength, faster slopes lead to increased ringing on all signals. Low or medium slope setting is best. Additional gate resistors or 1nF output capacitors do not bring any additional improvement. The layout already proves to be good with no additional components required!

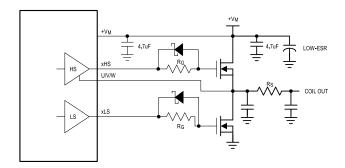


Figure 13: Bridge Design Example

6.3.3 Bridge Layout Considerations

- Tune the bridge layout for minimum loop inductivity. A compact layout is best.
- Keep MOSFET gate connections short and straight and avoid loop inductivity between bridge feed-back (U,V,W) and corresponding HS driver pin. Loop inductance is minimized with parallel traces, or adjacent traces on adjacent layers. A wider trace reduces inductivity (do not use minimum trace width).
- Place the TMCM-1690-TMCL near the low side MOSFETs GND connections, with its GND connections directly connected to the same GND plane.
- Optimize switching behavior by using lowest acceptable gate current setting.
- Check influence of optional components shown in Figure 9.
- Measure the performance of the bridge by probing BM pins directly at the bridge or at the TMC6100 using a short GND tip on the scope probe rather than a GND cable, if available.

6.3.4 Current Sensing Resistors

Direct coil current measurement is recommended for FOC in both hall- or encoder-mode operation. Therefore, the TMCM-1690-TMCL includes three current-sense amplifiers capable of handling high common mode ranges.

The following equation can be used to select the appropriate sense resistor.

$$R_{SENSE} = \frac{0.148V}{I_{PEAK_TARGET}} = \frac{0.148V}{\sqrt{2} \times I_{RMS\ TARGET}}$$

The power losses in these sense resistors can be calculated by the following formula:

$$P_{LOSS_RSNS} = (\frac{I_{PEAK_TARGET}}{\sqrt{2}})^2 \times R_{SENSE} = (I_{RMS_TARGET})^2 \times R_{SENSE}$$



TMCM-1690-TMCL supports bottom shunt current sensing as shown in Figure 14. For bottom shunt current sensing, the internal current-sense amplifiers have a gain of 10 and the outputs should again remain in the range of 0V to +3.3V. The output of the amplifiers is internally connected to a 12-bit ADC, which centers the zero current at +3.3V/2 = 1.65V. Margin of roughly 10% at the high side should be included to prevent saturation of the amplifiers and/or exceeding the full-scale range of the ADC when close to maximum current.

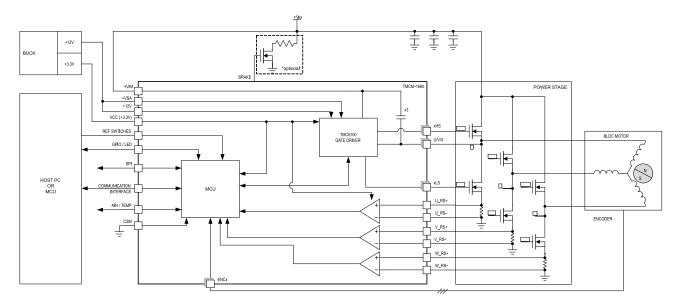


Figure 14: Bottom Shunt Current Sense

6.4 Diagnostics and Protections

TMCM-1690-TMCL supplies a complete set of diagnostic and protection capabilities, like short circuit protection and undervoltage detection. See the firmware manual for full details.

6.4.1 Temperature Sensors

TMCM-1690-TMCL includes a TEMP input for temperature monitoring of the external power stage. Place a thermistor in thermal contact with one of the external MOSFETs, as shown in Figure 15 to monitor the temperature of the bridge.

TMCM-1690-TMCL's on-board gate driver also integrates a four-level temperature sensor (120°C pre-warning and selectable 136°C/143°C/150°C thermal shutdown) for diagnostics and for protection of the IC and the power MOSFETs and adjacent components against excess heat. Choose the overtemperature level to safely cover error conditions like missing heat convection. In typical applications, however, heat is mainly generated by the power MOSFETs, and, at increased voltage, by the internal voltage regulators. For many applications, already the overtemperature pre-warning indicates an abnormal operation situation and can be used to initiate user warning or power reduction measures like motor current reduction. The thermal shutdown is just an emergency measure and temperature rising to the shutdown level should be prevented by design.

After triggering the overtemperature sensor (ot flag), the driver remains switched off until the system temperature falls below the pre-warning level (otpw) to avoid continuous heating to the shutdown level. Full details on software implementation of all temperature sensors can be found in the firmware user guide for each firmware version.



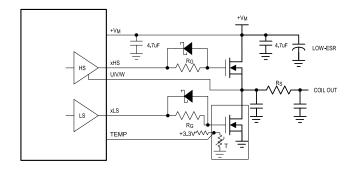


Figure 15: Thermistor Implementation

6.4.2 Gate Driver Short Circuit Protection

TMCM-1690-TMCL protects the MOSFET power stages against a short circuit or overload condition by monitoring the voltage drop in the high-side MOSFETs, as well as the voltage drop in the low-side MOSFETs (Figure 16). A programmable short detection delay allows adjusting the detector to work with very slow switching slopes. Additionally, the short detector allows filtering of the signal. This helps to prevent spurious triggering caused by effects of PCB layout, or long, adjacent motor cables. All control bits are available through an internal register. Additionally, the short detection is protected against single events, for example caused by electrostatic discharges (ESD events), by retrying up to three times (configurable between one and three) before switching off the motor continuously.

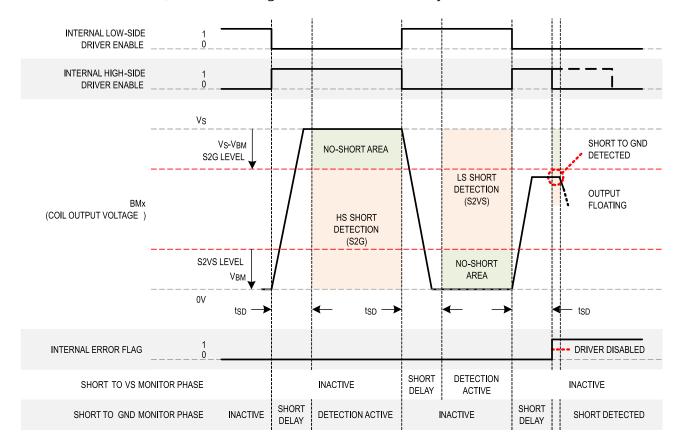


Figure 16: Short Detection (U/V/W Outputs)



The following is a list of configurable aspects of the short circuit protection scheme. Details on the setting ranges specifics about how to change them can be found in the firmware manuals.

- Short or overcurrent detector level for lowside FETs. Checks for voltage drop in LS MOSFET and/or bottom shunt sense resistor when in low side mode. This parameter may be tuned for sensitive detection.
- Short to GND detector level for highside FETs. Checks for voltage drop on high side MOSFET. Use high setting to avoid false detection.
- Spike filtering bandwidth for short detection. Increase value if erroneous short detection occurs.
- Number of retries after short detection until permanent bridge shutdown.
- Short detection delay. Ensure the delay covers the bridge switching time.
- Disable short to VS protection.
- · Disable short to GND protection.
- Option to respond individually to half bridge protection needs or to disable all bridges upon single half-bridge short condition.

6.4.3 Avoiding Power Supply Overshoot

To avoid power supply overshoot during events like deceleration where energy is fed back from the motor to the supply, the TMCM-1690-TMCL includes a brake chopper output, which can be connected to a low-side N-channel MOSFET. The brake chopper duty cycle is actively adapted to control overshoot on the supply. Figure ?? and Figure 14 show an example circuit.

7 TMCL Protocol Firmware

The Trinamic Motion Control Language (TMCL) is a versatile protocol that can be used with a CAN, UART, RS232, or RS485 interface. While it is mainly developed for evaluation kits and programming standalone TMCL applications, it is widely used by customers who like the intuitive and free to use graphical user interface that comes with it. This TMCL-IDE user interface is a flexible integrated development environment supporting the use of TMCL commands in direct mode and which monitors real-time behavior visualized in graphs, and logs and stores data. All settings can quickly be exported for use in own firmware project. Details on implementation are found in the TMCM-1690-TMCL TMCL firmware manual.

An easy-to-use, guided GUI is provided to ease bring-up and parametrization. For further ease of use TMCL programs can be stored in the on-board the electrically erasable programmable read-only memory (EEPROM), if available on a that board. Programs stored in EEPROM can be executed after power up or when triggered by the system host. An analog input is also available for simple standalone applications or evaluation.

The TMCM-1690-TMCL TMCL version can be used with a standard UART connection or any other serial interface when using an external transceiver (for example, RS485 or CAN).



8 Communication

8.1 RS485

For remote control and communication with a host system, the TMCM-1690-TMCL provides a two-wire RS485 bus interface. For proper operation, consider the following items when setting up an RS485 network:

1. BUS STRUCTURE:

The network topology should follow a bus structure as closely as possible. That is, the connection between each node and the bus itself should be as short as possible. Basically, it should be short compared to the length of the bus.

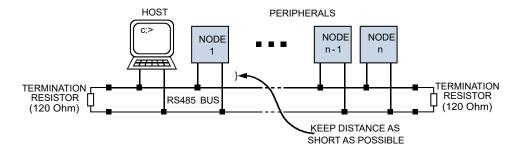


Figure 17: RS485 Bus Structure with Termination Resistors

2. BUS TERMINATION:

For longer buses and/or multiple nodes connected to the bus and/or high communication speeds, the bus should be properly terminated at both ends. The TMCM-1690-TMCL does not integrate any termination resistor. Therefore, 120Ω termination resistors at both ends of the bus have to be added externally.

3. NUMBER OF NODES:

The RS485 electrical interface standard (EIA-485) allows up to 32 nodes to be connected to a single bus. The bus transceiver used on the TMCM-1690-TMCL units (MAX22501) offers a significantly reduced bus load compared to the standard and allows a maximum of 255 units to be connected to a single RS485 bus using standard TMCL firmware.

Usually, reliable communication and maximum supported communication speed cannot be expected at the same time with the maximum number of nodes connected to one bus. Instead, a compromise has to be found between bus cable length, communication speed, and number of nodes.

4. COMMUNICATION SPEED:

The maximum RS485 communication speed supported by the TMCM-1690-TMCL hardware is 1Mb/s. Factory default is 115200 bit/s. Refer to the separate TMCM-1690-TMCL TMCL firmware manual for information regarding other possible communication speeds below the upper hardware limit.

5. NO FLOATING BUS LINES:

Avoid floating bus lines while neither the host nor one of the peripherals along the bus line is transmitting data (all bus nodes switched to receive mode). Floating bus lines may lead to communication errors. To ensure valid signals on the bus, it is recommended to use a resistor network connecting both bus lines to well defined logic levels.

There are two recommended options:

a) Add a resistor (bias) network on one side of the bus only. A 120Ω termination resistor is still required at both ends.



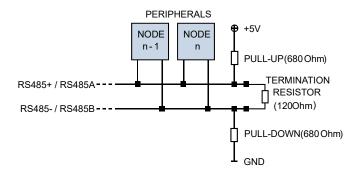


Figure 18: RS485 Bus Lines with Resistor (Bias) Network on one Side only

b) Add a resistor network at both ends of the bus in addition to the 120Ω termination resistors.

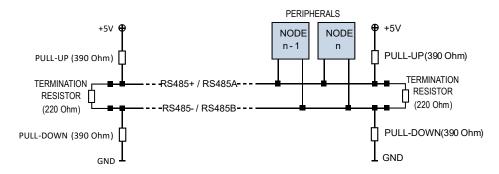


Figure 19: RS485 Bus Lines with dual Resistor network Line Termination

8.2 CAN

TMCM-1690-TMCL provides a CAN bus interface. The bus transceiver is not integrated on the TMCM-1690-TMCL. For proper operation, consider the following items when setting up a CAN network:

1. BUS STRUCTURE:

The network topology should follow a bus structure as closely as possible. That is, the connection between each node and the bus itself should be as short as possible. Basically, it should be short compared to the length of the bus.

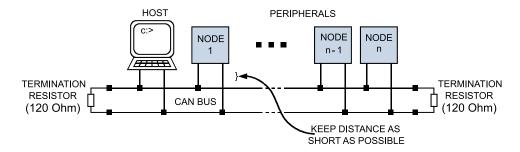


Figure 20: CAN Bus Structure with Termination Resistors

2. BUS TERMINATION:

For longer buses and/or multiple nodes connected to the bus and/or high communication speeds,



the bus should be properly terminated at both ends. The TMCM-1690-TMCL does not integrate any termination resistor. Therefore, 120Ω termination resistors at both ends of the bus have to be added externally. The number of nodes per CAN bus highly depend on bus length (longer bus -> less nodes) and communication speed (higher speed -> less nodes).



9 Absolute Maximum Ratings

Symbol	Description	Min	Max	Unit
VM	Motor supply voltage range	-0.5	65	V
VM	Short duration max (limited by peak voltage on charge pump output and internal bootstrap cap voltages)		70	V
VSA	Motor driver supply voltage range	-0.5	65	V
+12V	Motor driver supply voltage range	-0.5	15	٧
+3.3V	Logic supply voltage range	-0.3	4	V
U, V, W	Peak voltage due to inductive kick	-6	VSA + 6	V
LSU, LSV, LSW		-0.5	15	V
HSU, HSV, HSW		-0.5	VM + 15	V
U_RS+, U_RS-, V_RS+, V_RS-, W_RS+, W_RS-		-5	70	V
U_RS+ to U_RS-, V_RS+ to V_RS-, W_RS+ to W_RS-		-2	2	V
All other pins		-0.3	4	V
Continuous current into x_RS+ and x_RS-		-10	10	mA
Continuous current into any other pin		-5	5	mA
T _{ENV}	Operating temperature range	-30	60	°C
T _{SHELF}	Storage temperature range	-40	125	°C

Table 4: Absolute Maximum Ratings

NOTICE

Stresses outside the ranges listed in Table 4 may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure close to or outside the maximum rating conditions for extended periods may affect device reliability.



10 Electrical Characteristics

Symbol	Description	Min	Тур	Max	Unit
POWER SUP	PLY INPUTS OPERATING VOLTAGE RANGES				
V_{VM_IN}	VM Input Operating Voltage Range	10	48	60	V
V _{VSA_IN}	VSA Input Operating Voltage Range	10	12	60	V
V _{+12V_IN}	+12V Input Operating Voltage Range	11	12	13	V
V _{+3.3V_IN}	+3.3V Input Operating Voltage Range	3.0	3.3	3.6	٧
GATE DRIVE	R POWER SUPPLY CURRENT RATINGS	•			
I _S	Total gate driver supply current, driver disabled		10	15	mA
I _{VSA}	VSA supply current with f _{CLK} = 24MHz, internal clock, driver disabled		7		mA
LINEAR REG	ULATOR (+12V OUT PIN — ONLY WHEN OP	ERATING BEL	OW 24V)	1	
V _{12VOUT}	See also section on power supply requirements	10.8	11.5	12.2	V
DIGITAL PIN	S	1		1	
V _{IL}	Input logic level low			0.3 x V _{+3.3V}	V
V _{IH}	Input logic level high	0.7 x V _{+3.3V}			٧
V _{IN_HYST}	Input logic level hysteresis		0.1 x V _{+3.3V}		V
V _{OL}	Output low voltage, I _{OUT_LO} = 2mA			0.2	V
V _{OH}	Output high voltage, I _{OUT_HI} = -2mA	V _{+3.3V} - 0.2			V
I _{LEAK}	Input leakage current	-10		10	μ A
AIN, TEMP					
VI	Input voltage range	0		3.3	V
	Resolution		12		bits
GATE DRIVE	R				
R _{ONL}	R _{DS_ON} Low-Side Off-State Driver		1.0	1.6	Ω
R _{ONH}	R _{DS_ON} High-Side Off-State Driver		1.3	2.0	Ω
I _{SLPONLS0_2V}	Low-Side Gate Driver Current, Turning on, at V _{GS} = 2V, DRIVESTRENGTH = 0		400		mA
I _{SLPONLS2_2V}	Low-Side Gate Driver Current, Turning on, at V _{GS} = 2V, DRIVESTRENGTH = 2		800		mA
I _{SLPONLS3_2V}	Low-Side Gate Driver Current, Turning on, at V _{GS} = 2V, DRIVESTRENGTH = 3		1200		mA
I _{SLPOFFLS0_4V}	Low-Side Gate Driver Current, Turning off, at $V_{GS} = 4V$, DRIVESTRENGTH = 0		600		mA



I _{SLPOFFLS2_4V}	Low-Side Gate Driver Current, Turning off, at V _{GS} = 4V, DRIVESTRENGTH = 2		1200		mA
I _{SLPOFFLS3_4V}	Low-Side Gate Driver Current, Turning off, at V_{GS} = 4V, DRIVESTRENGTH = 3		1800		mA
I _{SLPONHS0_2V}	High-Side Gate Driver Current, Turning on, at V _{GS} = 2V, DRIVESTRENGTH = 0		400		mA
I _{SLPONHS2_2V}	High-Side Gate Driver Current, Turning on, at V _{GS} = 2V, DRIVESTRENGTH = 2		800		mA
I _{SLPONHS3_2V}	High-Side Gate Driver Current, Turning on, at V _{GS} = 2V, DRIVESTRENGTH = 3		1200		mA
I _{SLPOFFHS0_4V}	High-Side Gate Driver Current, Turning off, at V _{GS} = 4V, DRIVESTRENGTH = 0		600		mA
I _{SLPOFFHS2_4V}	High-Side Gate Driver Current, Turning off, at V _{GS} = 4V, DRIVESTRENGTH = 2		1200		mA
I _{SLPOFFHS3_4V}	High-Side Gate Driver Current, Turning off, at V _{GS} = 4V, DRIVESTRENGTH = 3		1800		mA
t _{BBM0}	Minimum Effective BBM Time, Individual LS and HS signals (Singleline = 0)	30	50	70	ns
t _{DLY}	Propagation Delay Time, Time from LS/HS Input signal change to start of driver output change	65	85	110	ns
t _{DLY_MATCH}	Propagation Delay Matching, Individual LS and HS signals (Singleline = 0)			10	ns
V _{CP}	Charge Pump Output Voltage	V _{12VOUT} - 2	V _{12VOUT} - 1		V
V _{VCP} - V _{VM}	Charge Pump Voltage Threshold for Undervoltage Detection, rising, using internal 5V regulator voltage	4.5	5.5	6.5	V
f _{CP}	Charge Pump Frequency		1/32 f _{CLKOSC}		Hz
GATE DRIVE	R INTERNAL CLOCK				
f _{CLKOSC}	T _J = -50°C		23.4		MHz
f_{CLKOSC}	T _J = 50°C	23.0	24.0	26.0	MHz
f_{CLKOSC}	T _J = 150°C		24.2		MHz
SHORT DETE	ECTION (VS CONNECTS TO VM INSIDE TMCN	Л-1690)	,		'
t _{SD0}	Short-to-GND Detection Delay, FILT_ISENSE = 0, S2xx_LEVEL = 6, shortdelay = 0	0.5	0.85	1.1	μς
t _{SD1}	Short-to-GND Detection Delay, shortde- lay = 1	1.1	1.6	2.2	μS
V_{BM}	Short Detection Level S2VS , Measurement includes drop in case of bottom shunt current sensing, S2VS_LEVEL = 15	1.4	1.56	1.72	V



V _{BM}	Short Detection Level S2VS, Measurement includes drop in case of bottom shunt current sensing, S2VS_LEVEL = 6	0.550	0.625	0.700	V
V _{VS} - V _{BM}	S2G_LEVEL = 15, VM < 52V	1.30	1.56	1.85	٧
V _{VS} - V _{BM}	S2G_LEVEL = 15, VM < 60V	1.00			٧
V _{VS} - V _{BM}	S2G_LEVEL = 6, VM < 52V	0.460	0.625	0.850	٧
V _{VS} - V _{BM}	S2G_LEVEL = 6, VM < 60V	0.200			٧
CURRENT SE	NSE INPUTS				
V _{CM}	Input common mode range	-0.3		65	٧
V _{SENSE}	Input differential voltage range	-0.165		0.165	V
	Nominal gain		10		V/V

Table 5: General Operational Ratings of the Module



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13 Supplemental Directives

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13.7 Collateral Documents & Tools

This product documentation is related and/or associated with additional tool kits, firmware and other items, as provided on the product page at: www.analog.com.



14 Revision History

14.1 Hardware Revision

Version	Date	Description
V1.00	10/23	Initial release version

Table 6: Hardware Revision

14.2 Document Revision

Version	Date	Description
0	11/23	Initial release version
1	04/24	Order codes updated Section "Current Sensing Resistors" updated Figure 6 and Figure 8 quality improved

Table 7: Document Revision



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Analog Devices Inc.:

TMCM-1690-TMCL TMCM-1690-TMCL-T